

Data Sheet

FEATURES

Qualified for automotive applications Latch-up proof 8 kV human body model (HBM) ESD rating Low on resistance (<10 Ω) ±9 V to ±22 V dual-supply operation 9 V to 40 V single-supply operation 48 V supply maximum ratings Fully specified at ±15 V, ±20 V, +12 V, and +36 V Vss to VDD analog signal range

APPLICATIONS

Relay replacement Automatic test equipment Data acquisition Instrumentation Avionics Audio and video switching Communication systems

GENERAL DESCRIPTION

The ADG5412W contains four independent single-pole/singlethrow (SPST) switches. The ADG5412W switches turn on with Logic 1. Each switch conducts equally well in both directions when on, and each switch has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked.

The ADG5412W does not have a V_L pin. The digital inputs are compatible with 3 V logic inputs over the full operating supply range.

The on-resistance profile is very flat over the full analog input range, which ensures good linearity and low distortion when switching audio signals. High switching speed also makes the devices suitable for video signal switching.

High Voltage Latch-Up Proof, Quad SPST Switches

ADG5412W

1695-001

FUNCTIONAL BLOCK DIAGRAM

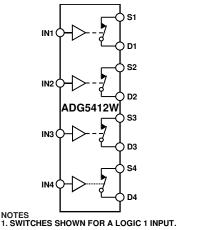


Figure 1.

PRODUCT HIGHLIGHTS

- 1. Trench isolation guards against latch-up. A dielectric trench separates the P and N channel transistors thereby preventing latch-up even under severe overvoltage conditions.
- 2. Low Ron.
- 3. Dual-supply operation. For applications where the analog signal is bipolar, the ADG5412W can be operated from dual supplies up to ±22 V.
- 4. Single-supply operation. For applications where the analog signal is unipolar, the ADG5412W can be operated from a single rail power supply up to 40 V.
- 5. 3 V logic compatible digital inputs: $V_{INH} = 2.0$ V, $V_{INL} = 0.8$ V.
- 6. No V_L logic power supply required.

Rev. A

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REVISION HISTORY

3/14—Rev. 0 to Rev. A	
Added TSSOP (RU-16) ModelU	Jniversal

12/13—Revision 0: Initial Version

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SPECIFICATIONS

±15 V DUAL SUPPLY

 V_{DD} = +15 V \pm 10%, V_{SS} = –15 V \pm 10%, GND = 0 V, T_{A} = –40°C to +125°C, unless otherwise noted.

Table 1.

Parameter	ter Typ Min (T _A =		Max	Unit	Test Conditions/Comments	
ANALOG SWITCH		(,				
Analog Signal Range			V _{DD} to V _{ss}	V		
On Resistance, R_{ON}		9.8	16	Ω	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V},$ $V_{S} = \pm 10 \text{ V}, I_{S} = -10 \text{ mA};$ see Figure 24	
On-Resistance Match Between Channels, ΔR_{ON}		0.35	1.1	Ω	$V_s = \pm 10 V$, $I_s = -10 mA$	
On-Resistance Flatness, R _{FLAT (ON)}		1.2	2.2	Ω	$V_s = \pm 10 V$, $I_s = -10 mA$	
LEAKAGE CURRENTS					$V_{DD} = +16.5 V$, $V_{SS} = -16.5 V$	
Source Off Leakage, I_s (Off)		±0.05	±10	nA	$V_s = \pm 10 V$, $V_D = \mp 10 V$; see Figure 27	
Drain Off Leakage, I_D (Off)		±0.05	±10	nA	$V_S = \pm 10 V$, $V_D = \mp 10 V$; see Figure 27	
Channel On Leakage, I _D (On), I _S (On)		±0.1	±20	nA	$V_{\rm S} = V_{\rm D} = \pm 10$ V; see Figure 23	
DIGITAL INPUTS						
Input High Voltage, V _{INH}	2.0			V		
Input Low Voltage, V _{INL}			0.8	V		
Input Current, Inl or Inh		0.002	±0.1	μA	$V_{IN} = V_{GND} \text{ or } V_{DD}$	
Digital Input Capacitance, C _{IN}		2.5		pF		
t _{on}		170	262	ns	$V_s = 10 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$	
t _{off}		120	182	ns	$V_s = 10 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$	
Charge Injection, Q _{INJ}		240		рС	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31	
Off Isolation		-78		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26	
Channel-to-Channel Crosstalk		-70		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25	
Total Harmonic Distortion + Noise		0.009		%	$R_L = 1 \text{ k}\Omega$, 15 V p-p, f = 20 Hz to 20 kHz; see Figure 28	
–3 dB Bandwidth		167		MHz	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29	
Insertion Loss		-0.7		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 29	
Cs (Off)		18		pF	$V_s = 0 V$, $f = 1 MHz$	
C _D (Off)		18		pF	$V_{s} = 0 V, f = 1 MHz$	
C _D (On), C _s (On)		60		pF	$V_{s} = 0 V, f = 1 MHz$	
POWER REQUIREMENTS					$V_{DD} = +16.5 V, V_{SS} = -16.5 V$	
ldd		45	70	μΑ	Digital inputs = $0 V \text{ or } V_{DD}$	
lss		0.001	1	μA	Digital inputs = $0 V \text{ or } V_{DD}$	
V _{DD} /V _{SS}	±9		±22	V	GND = 0V	

±20 V DUAL SUPPLY

 V_{DD} = +20 V \pm 10%, V_{SS} = -20 V \pm 10%, GND = 0 V, T_{A} = -40°C to +125°C, unless otherwise noted.

Table 2.

Parameter	Min	Typ (T _A = 25°C)	Max	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V _{DD} to V _{ss}	V	
On Resistance, R _{on}		9	15	Ω	$V_{DD} = +18 V$, $V_{SS} = -18 V$, $V_{S} = \pm 15 V$, $I_{S} = -10 mA$; see Figure 24
On-Resistance Match Between Channels, ΔR _{oN}		0.35	1.1	Ω	$V_s = \pm 15 V$, $I_s = -10 mA$
On-Resistance Flatness, R _{FLAT (ON)}		1.5	2.5	Ω	$V_s = \pm 15 V$, $I_s = -10 mA$
LEAKAGE CURRENTS					$V_{DD} = +22 V, V_{SS} = -22 V$
Source Off Leakage, Is (Off)		±0.05	±10	nA	$V_s = \pm 15 V$, $V_D = \mp 15 V$; see Figure 27
Drain Off Leakage, I _D (Off)		±0.05	±10	nA	$V_s = \pm 15 V$, $V_D = \mp 15 V$; see Figure 27
Channel On Leakage, I_D (On), I_S (On)		±0.1	±20	nA	$V_s = V_D = \pm 15 V$; see Figure 23
DIGITAL INPUTS					
Input High Voltage, V _{INH}	2.0			V	
Input Low Voltage, VINL			0.8	V	
Input Current, IINL or IINH		0.002		μΑ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μΑ	
Digital Input Capacitance, C _{IN}		2.5		pF	
DYNAMIC CHARACTERISTICS ¹					
t _{on}		158	240	ns	$V_s = 10 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
t _{OFF}		110	170	ns	$V_s = 10 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
Charge Injection, Q _{INJ}		310		pC	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation		-78		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk		-70		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25
Total Harmonic Distortion + Noise		0.007		%	$R_L = 1 k\Omega$, 20 V p-p, f = 20 Hz to 20 kHz; see Figure 28
–3 dB Bandwidth		160		MHz	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29
Insertion Loss		-0.6		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 29
C _s (Off)		17		pF	$V_{s} = 0 V, f = 1 MHz$
C_{D} (Off)		17		pF	$V_{s} = 0 V, f = 1 MHz$
C _D (On), C _s (On)		60		pF	$V_{s} = 0 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = +22 V, V_{SS} = -22 V$
IDD		50	110	μA	Digital inputs = $0 V \text{ or } V_{DD}$
Iss		0.001	1	μA	Digital inputs = $0 V \text{ or } V_{DD}$
V _{DD} /V _{SS}	±9		±22	V	GND = 0V

12 V SINGLE SUPPLY

 V_{DD} = 12 V \pm 10%, V_{SS} = 0 V, GND = 0 V, T_{A} = -40°C to +125°C, unless otherwise noted.

Table 3.

Parameter	Min	Typ (T _A = 25°C)	Max	Unit	Test Conditions/Comments
ANALOG SWITCH		(
Analog Signal Range			$0 V to V_{DD}$	V	
On Resistance, R _{ON}		19	31	Ω	$V_{DD} = 10.8 V$, $V_{SS} = 0 V$, $V_{S} = 0 V$ to 10 V, $I_{S} = -10 mA$; see Figure 24
On-Resistance Match Between Channels, ΔR_{ON}		0.4	1.2	Ω	$V_s = 0 V$ to 10 V, $I_s = -10 mA$
On-Resistance Flatness, R _{FLAT (ON)}		4.4	7.5	Ω	$V_s = 0 V$ to 10 V, $I_s = -10 mA$
LEAKAGE CURRENTS					$V_{DD} = 13.2 V, V_{SS} = 0 V$
Source Off Leakage, Is (Off)		±0.05	±10	nA	$V_s = 1 V/10 V$, $V_D = 10 V/1 V$; see Figure 27
Drain Off Leakage, I _D (Off)		±0.05	±10	nA	$V_s = 1 V/10 V$, $V_D = 10 V/1 V$; see Figure 27
Channel On Leakage, I _D (On), I _S (On)		±0.1	±20	nA	$V_s = V_D = 1 \text{ V}/10 \text{ V}$; see Figure 23
DIGITAL INPUTS					
Input High Voltage, V _{INH}	2.0			V	
Input Low Voltage, VINL			0.8	V	
Input Current, I _{INL} or I _{INH}		0.002		μA	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μA	
Digital Input Capacitance, C _{IN}		2.5		pF	
DYNAMIC CHARACTERISTICS ¹					
ton		225	403	ns	$V_s = 8 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
t _{OFF}		150	247	ns	$V_s = 8 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
Charge Injection, Q _{INJ}		95		рС	$V_s = 6 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation		-78		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk		-70		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25
Total Harmonic Distortion + Noise		0.07		%	R_L = 1 kΩ, 6 V p-p, f = 20 Hz to 20 kHz; see Figure 28
–3 dB Bandwidth		180		MHz	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29
Insertion Loss		-1.3		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 29
Cs (Off)		22		pF	$V_s = 6 V, f = 1 MHz$
C_{D} (Off)		22		pF	$V_s = 6 V, f = 1 MHz$
C _D (On), C _s (On)		58		pF	$V_s = 6 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = 13.2 V$
lod		40	65	μA	Digital inputs = $0 V \text{ or } V_{DD}$
V _{DD}	9		40	V	$GND = 0 V, V_{ss} = 0 V$

36 V SINGLE SUPPLY

 V_{DD} = 36 V \pm 10%, V_{SS} = 0 V, GND = 0 V, T_{A} = -40°C to +125°C, unless otherwise noted.

Table 4.

Parameter	Min	Typ (T _A = 25°C)	Max	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$0 V to V_{DD}$	V	
On Resistance, R₀N		10.6	17	Ω	$V_{DD} = 32.4 V$, $V_{SS} = 0 V$, $V_{S} = 0 V$ to 30 V, $I_{S} = -10 mA$; see Figure 24
On-Resistance Match Between Channels, ΔR _{ON}		0.35	1.1	Ω	V_{S} = 0 V to 30 V, I_{S} = -10 mA
On-Resistance Flatness, R _{FLAT(ON)}		2.7	4.5	Ω	$V_s = 0 V$ to 30 V, $I_s = -10 mA$
LEAKAGE CURRENTS					$V_{DD} = 39.6 V, V_{SS} = 0 V$
Source Off Leakage, Is (Off)		±0.05	±10	nA	$V_{s} = 1 \text{ V}/30 \text{ V}, V_{D} = 30 \text{ V}/1 \text{ V};$ see Figure 27
Drain Off Leakage, I_D (Off)		±0.05	±10	nA	$V_s = 1 V/30 V$, $V_D = 30 V/1 V$; see Figure 27
Channel On Leakage, I_D (On), I_S (On)		±0.1	±20	nA	$V_s = V_D = 1 V/30 V$; see Figure 23
DIGITAL INPUTS					
Input High Voltage, V _{INH}	2.0			V	
Input Low Voltage, VINL			0.8	V	
Input Current, I _{INL} or I _{INH}		0.002	±0.1	μΑ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
Digital Input Capacitance, C _{IN}		2.5		pF	
DYNAMIC CHARACTERISTICS ¹					
ton		180	248	ns	$V_s = 18 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
toff		130	174	ns	$V_s = 18 V$; see Figure 30, $R_L = 300 \Omega$, $C_L = 35 pF$
Charge Injection, Q _{INJ}		280		pC	$V_s = 18 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation		-78		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk		-70		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; Figure 25
Total Harmonic Distortion + Noise		0.03		%	$R_L = 1 \text{ k}\Omega$, 18 V p-p, f = 20 Hz to 20 kHz; see Figure 28
-3 dB Bandwidth		174		MHz	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29
Insertion Loss		-0.8		dB	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 29
C _s (Off)		18		pF	$V_s = 18 V, f = 1 MHz$
$C_{\rm D}$ (Off)		18		pF	$V_{s} = 18 V, f = 1 MHz$
C_D (On), C_s (On)		58		pF	$V_{s} = 18 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = 39.6 V$
lod		80		μA	Digital inputs = $0 V \text{ or } V_{DD}$
		100	130	μA	
V _{DD}	9		40	V	$GND = 0 V, V_{SS} = 0 V$

CONTINUOUS CURRENT PER CHANNEL, Sx OR Dx

Table 5.				
Parameter	25°C	85°C	125°C	Unit
CONTINUOUS CURRENT, Sx OR Dx				
$V_{DD} = +15 V$, $V_{SS} = -15 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	89	59	37	mA maximum
LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	160	94	49	mA maximum
$V_{DD} = +20 V$, $V_{SS} = -20 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	95	63	39	mA maximum
LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	170	98	50	mA maximum
$V_{DD} = 12 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	61	43	29	mA maximum
LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	110	70	42	mA maximum
$V_{DD} = 36 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	80	54	35	mA maximum
LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	144	87	47	mA maximum

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ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 6.

Parameter	Rating
V _{DD} to V _{SS}	48 V
V _{DD} to GND	–0.3 V to +48 V
Vss to GND	+0.3 V to -48 V
Analog Inputs ¹	V _{SS} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	V _{ss} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, Sx or Dx Pins	278 mA (pulsed at 1 ms, 10% duty cycle maximum)
Continuous Current, Sx or Dx ²	Data + 15%
Temperature Range	
Operating	-40°C to +125°C
Storage	–65°C to +150°C
Junction Temperature	150°C
Thermal Impedance, θ _{JA}	
16-Lead TSSOP (4-Layer Board)	112.6°C/W
16-Lead LFCSP (4-Layer Board)	30.4°C/W
Reflow Soldering Peak Temperature, Pb Free	As per JEDEC J-STD-020

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating can be applied at any one time.

ESD CAUTION

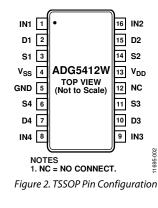


ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

¹ Overvoltages at the INx, Sx, and Dx pins are clamped by internal diodes. Limit current to the maximum ratings given.

² See Table 5.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



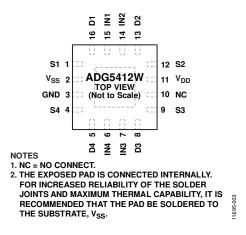


Figure 3. LFCSP Pin Configuration

Table 7. Pin Function Descriptions

Р	in No.		
TSSOP	LFCSP	Mnemonic	Description
1	15	IN1	Logic Control Input 1.
2	16	D1	Drain Terminal 1. This pin can be an input or output.
3	1	S1	Source Terminal 1. This pin can be an input or output.
4	2	Vss	Most Negative Power Supply Potential.
5	3	GND	Ground (0 V) Reference.
6	4	S4	Source Terminal 4. This pin can be an input or output.
7	5	D4	Drain Terminal 4. This pin can be an input or output.
8	6	IN4	Logic Control Input 4.
9	7	IN3	Logic Control Input 3.
10	8	D3	Drain Terminal 3. This pin can be an input or output.
11	9	S3	Source Terminal 3. This pin can be an input or output.
12	10	NC	No Connection.
13	11	VDD	Most Positive Power Supply Potential.
14	12	S2	Source Terminal 2. This pin can be an input or output.
15	13	D2	Drain Terminal 2. This pin can be an input or output.
16	14	IN2	Logic Control Input 2.
	EP	Exposed Pad	The exposed pad is connected internally. For increased reliability of the solder joints and maximum thermal capability, it is recommended that the pad be soldered to the substrate, V_{ss} .

Table 8. ADG5412W Truth Table

INx	Switch Condition
1	On
0	Off

TYPICAL PERFORMANCE CHARACTERISTICS

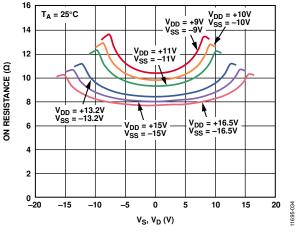
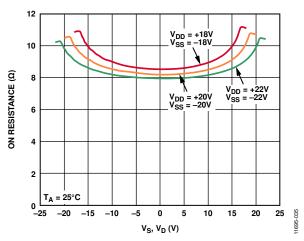


Figure 4. Ron as a Function of Vs, VD (Dual Supply)





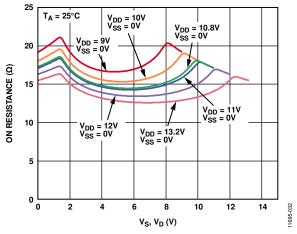


Figure 6. Ron as a Function of Vs, VD (Single Supply)

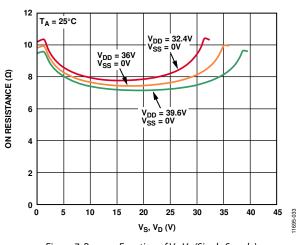


Figure 7. Ron as a Function of Vs, VD (Single Supply)

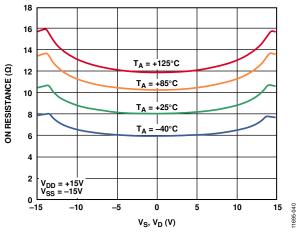


Figure 8. R_{ON} as a Function of V_S (V_D) for Different Temperatures, ± 15 V Dual Supply

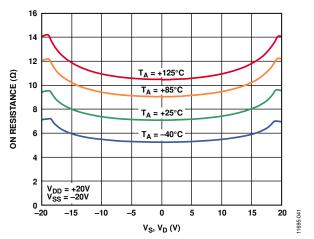


Figure 9. R_{ON} as a Function of V_{S} (V_{D}) for Different Temperatures, ± 20 V Dual Supply

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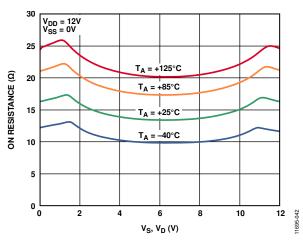


Figure 10. R_{ON} as a Function of V_S (V_D) for Different Temperatures, 12 V Single Supply

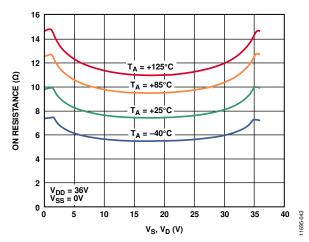


Figure 11. Row as a Function of Vs (Vb) for Different Temperatures, 36 V Single Supply

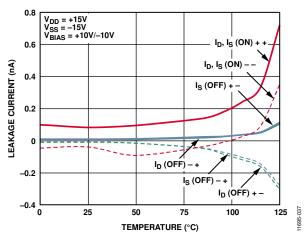


Figure 12. Leakage Currents vs. Temperature, ± 15 V Dual Supply

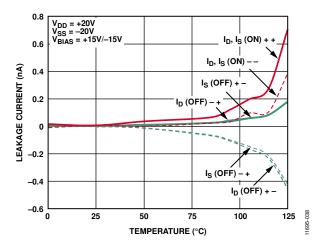
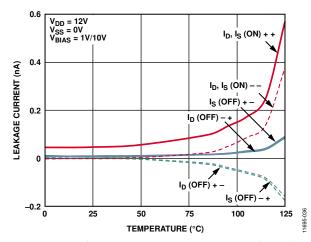


Figure 13. Leakage Currents vs. Temperature, ±20 V Dual Supply





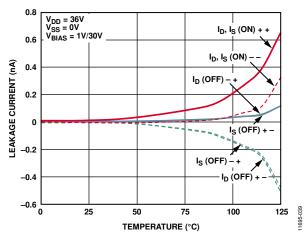


Figure 15. Leakage Currents vs. Temperature, 36 V Single Supply

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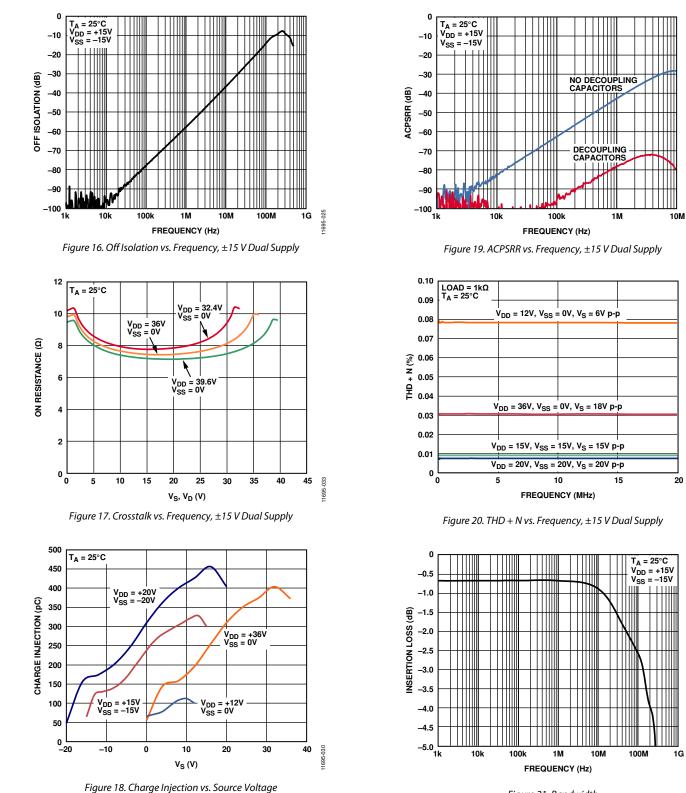


Figure 21. Bandwidth

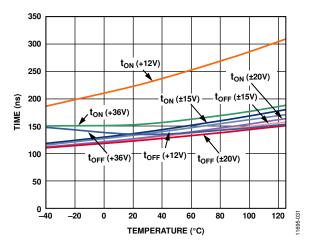
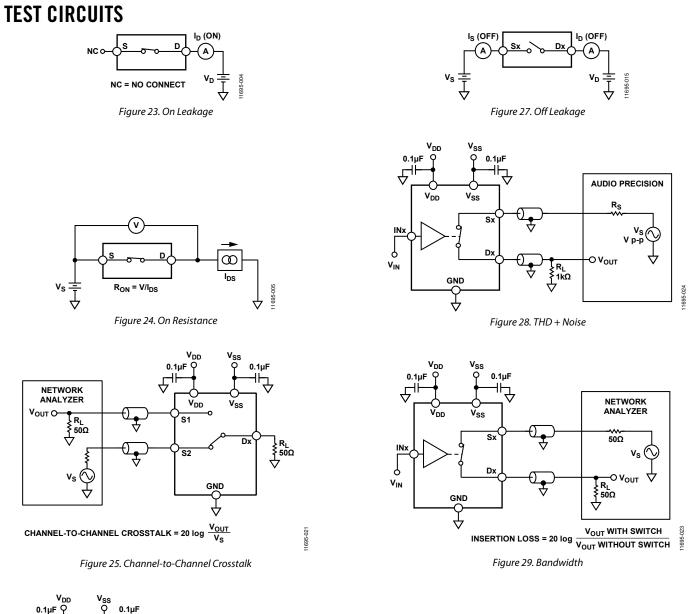


Figure 22. ton, toFF Times vs. Temperature



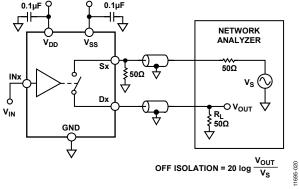
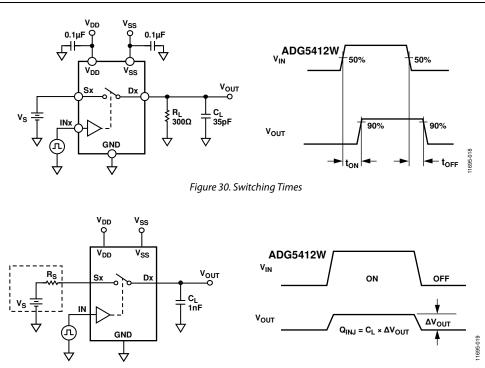
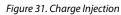


Figure 26. Off Isolation





TERMINOLOGY

\mathbf{I}_{DD}

 $I_{\rm DD}$ represents the positive supply current.

Iss

 $\ensuremath{I_{\text{SS}}}$ represents the negative supply current.

VD, Vs

 $V_{\rm D}$ and $V_{\rm S}$ represent the analog voltage on Terminal D and Terminal S, respectively.

Ron

 $R_{\mbox{\scriptsize ON}}$ represents the ohmic resistance between Terminal D and Terminal S.

ΔR_{ON}

 $\Delta R_{\rm ON}$ represents the difference between the $R_{\rm ON}$ of any two channels.

$R_{FLAT (ON)}$

Flatness that is defined as the difference between the maximum and minimum value of on resistance measured over the specified analog signal range is represented by $R_{FLAT (ON)}$.

Is (Off)

 $I_{\text{S}}\left(\text{Off}\right)$ is the source leakage current with the switch off.

I_D (Off)

 $I_{\rm D}\left(Off\right)$ is the drain leakage current with the switch off.

I_D (On), I_S (On)

 $I_{\rm D}$ (On) and $I_{\rm S}$ (On) represent the channel leakage currents with the switch on.

VINL

 $V_{\mbox{\scriptsize INL}}$ is the maximum input voltage for Logic 0.

VINH

 V_{INH} is the minimum input voltage for Logic 1.

$I_{\rm INL}, I_{\rm INH}$

 $I_{\rm INL}$ and $I_{\rm INH}$ represent the low and high input currents of the digital inputs.

C_D (Off)

 C_D (Off) represents the off switch drain capacitance, which is measured with reference to ground.

Cs (Off)

C_s (Off) represents the off switch source capacitance, which is measured with reference to ground.

C_D (On), C_s (On)

 C_D (On) and C_S (On) represent on switch capacitances, which are measured with reference to ground.

Cin

CIN is the digital input capacitance.

ton

 $t_{\rm ON}$ represents the delay between applying the digital control input and the output switching on.

toff

 $t_{\mbox{\scriptsize OFF}}$ represents the delay between applying the digital control input and the output switching off.

t_D

 $t_{\rm D}$ represents the off time measured between the 80% point of both switches when switching from one address state to another.

Off Isolation

Off isolation is a measure of unwanted signal coupling through an off switch.

Charge Injection

Charge injection is a measure of the glitch impulse transferred from the digital input to the analog output during switching.

Crosstalk

Crosstalk is a measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Bandwidth

Bandwidth is the frequency at which the output is attenuated by 3 dB.

On Response

On response is the frequency response of the on switch.

Insertion Loss

Insertion loss is the loss due to the on resistance of the switch.

Total Harmonic Distortion + Noise (THD + N)

The ratio of the harmonic amplitude plus noise of the signal to the fundamental is represented by THD + N.

AC Power Supply Rejection Ratio (ACPSRR)

ACPSRR is the ratio of the amplitude of signal on the output to the amplitude of the modulation. This is a measure of the ability of the part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p.

APPLICATIONS INFORMATION

The ADG54xx family of switches and multiplexers provide a robust solution for instrumentation, industrial, automotive, aerospace, and other harsh environments that are prone to latch-up, which is an undesirable high current state that can lead to device failure and persists until the power supply is turned off. The ADG5412W high voltage switches allow single-supply operation from 9 V to 40 V and dual-supply operation from ± 9 V to ± 22 V. The ADG5412W (as well as other select devices within the same family) achieve an 8 kV human body model ESD rating, which provides a robust solution eliminating the need for separate protect circuitry designs in some applications.

TRENCH ISOLATION

In the ADG5412W, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in junction isolated switches, are eliminated, and the result is a completely latch-up proof switch.

In junction isolation, the N and P wells of the PMOS and NMOS transistors form a diode that is reverse-biased under normal operation. However, during overvoltage conditions, this diode can become forward-biased. A silicon controlled rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current that, in turn, leads to latch-up. With trench isolation, this diode is removed, and the result is a latch-up proof switch.

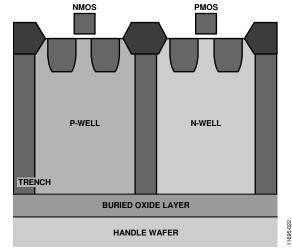
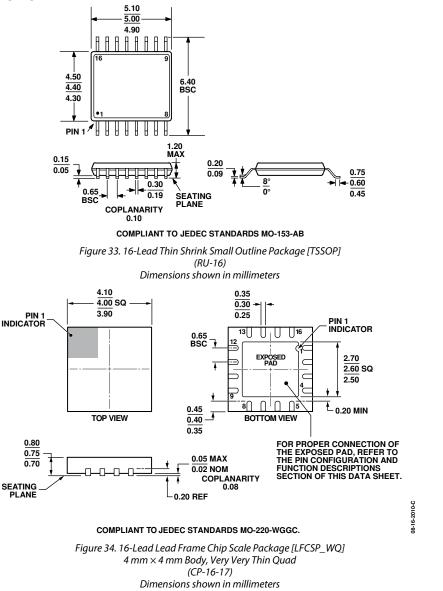


Figure 32. Trench Isolation

OUTLINE DIMENSIONS



ORDERING GUIDE

Model ^{1, 2}	Temperature Range	Package Description	Package Option
ADG5412WBRUZ-REEL7	-40°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG5412WBCPZ-REEL7	-40°C to +125°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-17

 1 Z = RoHS Compliant Part.

 2 W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADG5412W models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

NOTES

Data Sheet

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